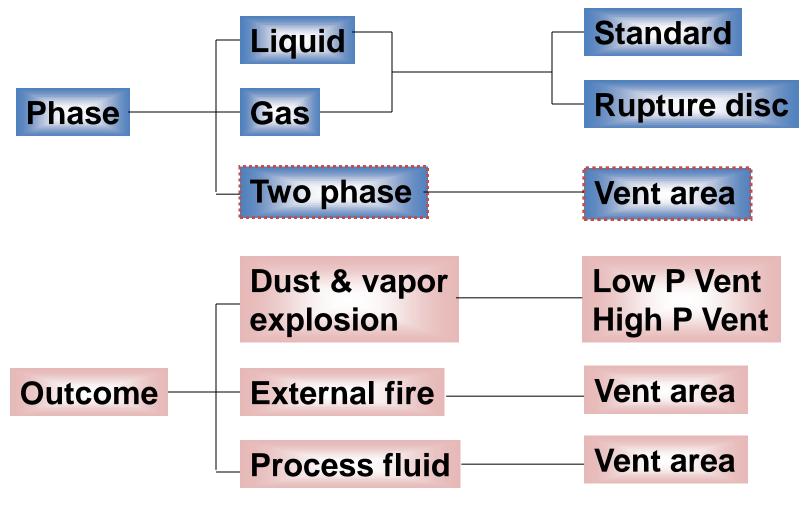
# **Relief System Sizing**

# **Calculating Relief Size I**

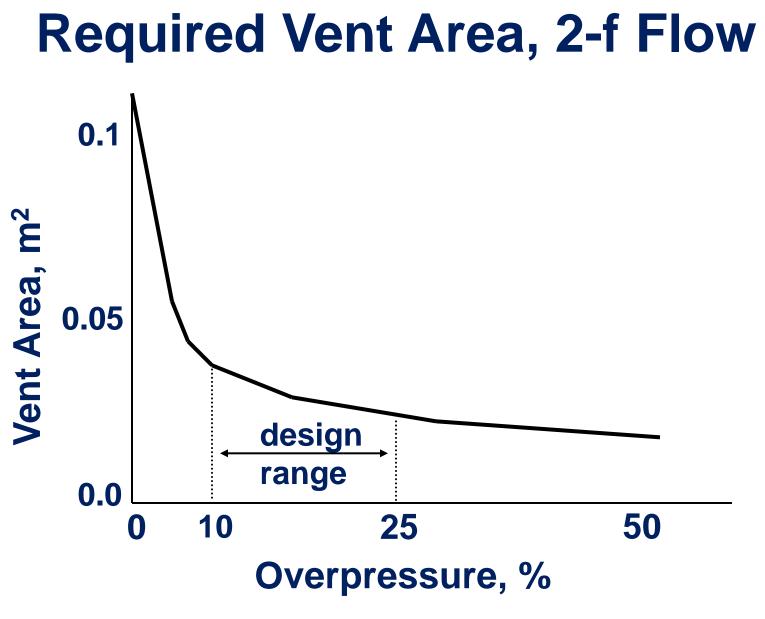
- Conventional spring-operated reliefs in liquid or vapor-gas service
- Rupture disc in liquid or vapor-gas service
- Two-phase flow during runaway rxn
- Reliefs for dust and vapor explosion
- Reliefs for external fire
- Reliefs for thermal expansion of process fluid

# **Calculating Relief Size II**



## **Relief Area Requirements**

- Minimum flow to hold valve seat in open position: 25-30 % of maximum flow
  - Low flow can lead to rapid opening and closing (*chattering*)
- Overpressures are designed to be 10 to 25 % above set pressures to prevent excessive vent sizes
- To hold pressures near the set pressures would require much larger vent sizes



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## **Spring Relief Area for Liquids**

#### Assume orifice flow through the valve port:

$$Q_{v} = \overline{u} A = A C_{o} \sqrt{\frac{2g_{c} \Delta P}{\rho}}$$

Eqn 4-6, p. 114

$$A = \frac{Q_v}{\overline{u}} = \left[\frac{\operatorname{in}^2(\mathrm{psi})^{1/2}}{38.0\mathrm{gpm}}\right] \frac{Q_v}{C_o} \sqrt{\frac{\rho / \rho_{ref}}{\Delta P}}$$

- $\bar{u}$  is the liquid velocity through the spring relief,
- $C_{o}$  is the discharge coefficient,
- $\Delta P$  is the pressure drop across the relief, and
  - $\rho$  is the liquid density

## **Computed Area for Liquids**

- A is computed area for device sizing as contrasted to effective valve area during use
- Max pressure in the API equation is 25 % above the set pressure
- For C<sub>o</sub> use the conservative value of 0.61 unless more information is available
- **4**  $K_v, K_p, K_b$  are correction factors for use of the API equation with various liquid viscosities, maximum pressures, and backpressure.

## **Spring Relief Area for Liquids**

**API correction factors included for wide applications:** 

$$A = \left[\frac{\text{in}^2 \text{psi}^{1/2}}{38 \text{gpm}}\right] \frac{Q_v}{C_k K_k K_b} \sqrt{\frac{\rho / \rho_{ref}}{1.25 P_s - P_b}}$$

A is the computed relief area (in<sup>2</sup>),



 $C_{o}$  is the discharge coefficient (unitless),

 $K_{\rm v}$  is the viscosity correction (unitless),

 $K_{\rm p}$  is the overpressure correction (unitless),

 $\vec{K_{\rm b}}$  is the backpressure correction (unitless),

( $\rho/\rho_{\rm ref}$ ) is the specific gravity of the liquid (unitless),

 $P_s$  is the gauge set pressure (lb<sub>f</sub>/in<sup>2</sup>)

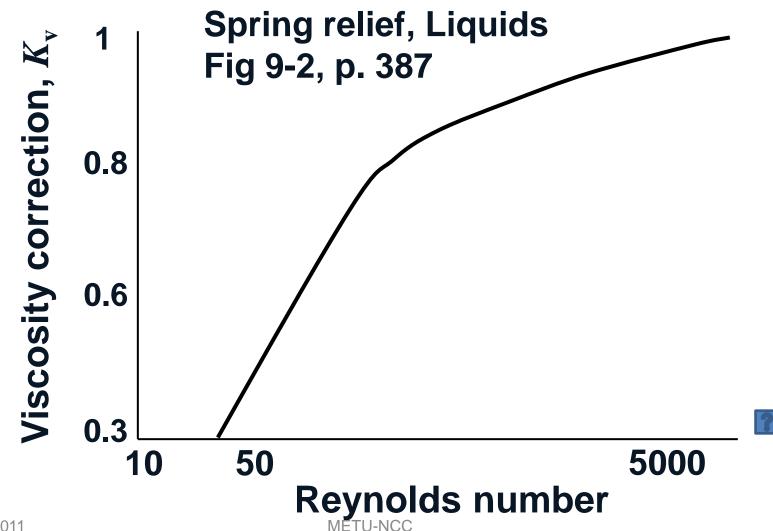
 $P_b$ , is the gauge backpressure (lb<sub>f</sub>/in<sup>2</sup>)

## **Correct Area for Viscosity:** *K*<sub>v</sub>

- Higher the viscosity the higher the friction losses through the valve
- Higher the viscosity, the smaller the Reynolds number, Re, and smaller the K<sub>v</sub> and therefore the larger the required A
- $\blacksquare$   $R_e$  usually is > 5,000. Then  $K_v$  is ~ 1.
- **4** For low Re ,  $K_v$  is a strong function of Re

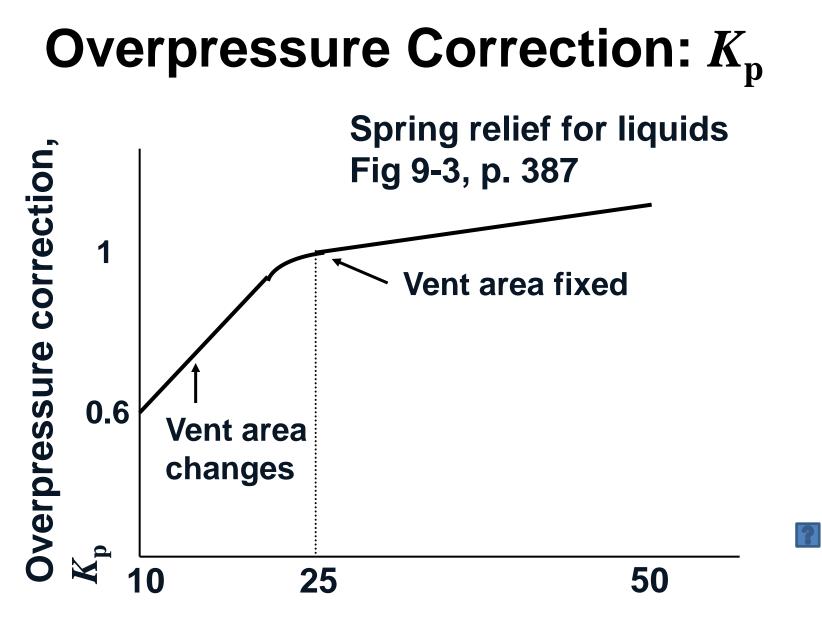
$$K_{\rm v} = \sqrt{\frac{1}{\frac{170}{\text{Re}} + 0.98}}$$

#### **Viscosity Correction Factor:** *K*<sub>v</sub>



# **Correct** A for **Overpressure**: $K_p$

- **4** 1.25  $P_s$   $P_b$  = △P for 25 % overpressure (OP); use a correction factor,  $K_p$ , for OP within 10 - 50 %
- **4** OP correction factor:  $K_p = 1$  for 25 % OP
- Above 25 %, the vent area is fixed, so flow rate change only with pressure drop: K<sub>p</sub> is a weak function of pressure in this range
- Below 25 %, the vent area changes with pressure, so flow rate changes with pressure drop and with area: K<sub>p</sub> is a strong function of pressure in this range.



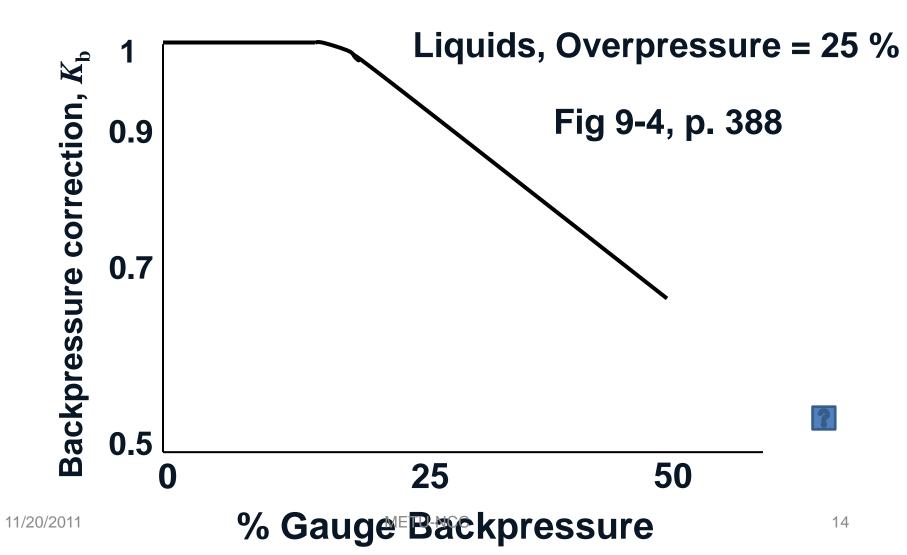
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**Overpressure**, %

## **Correct Area for Backpressure:** *K*<sub>b</sub>

- P<sub>b</sub> in basic API equation corrects for effects of backpressures in conventional valves (set pressure and flow rate
- Higher the backpressure, the lower the flow: larger the calculated required area, A
- For balanced bellows valves, a correction factor, K<sub>b</sub>, must be included because the set pressure does not increase as backpressure increases
- **4** The higher the backpressure, the smaller the  $K_{\rm b}$  and the larger the required A for a given  $Q_{\rm v}$
- **4** Ex 9-1, p 388 relief sizing

#### **K**<sub>b</sub> for Balanced-Bellows Reliefs



## **Spring Relief Valves for Gases**

In general, flow is critical with  $P_{ch} > P_{ext}$ :

$$(Q_m)_{ch} = C_o A P_{\sqrt{\frac{\gamma g_c M}{R_g T} (\frac{2}{\gamma + 1})^{(\gamma + 1)/(\gamma - 1)}}}$$
Eqn 4-50 p. 133

$$A = \frac{Q_m}{C_o \ \chi K_b P} \sqrt{\frac{T z}{M}}$$

z, compressibility factorP, max absolute dischargepressure

$$\chi = \sqrt{\frac{\gamma g_c}{R_g} \left(\frac{2}{\gamma + 1}\right)^{(\gamma + 1)/(\gamma - 1)}}$$

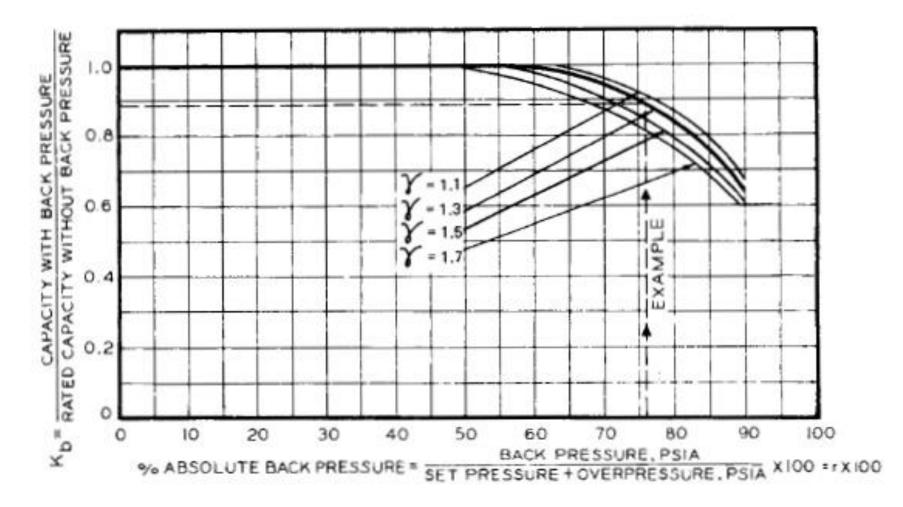
#### **Vent Area Equation for Gases**

- **4** Separate  $K_{\rm b}$  correction for each value type:
  - Standard valves, Fig 9-5, balanced bellows, Fig 9-6
  - For larger backpressure,  $K_{\rm b}$  smaller and A larger
- $\mathbf{4} C_{0}$ : if not known use 0.975
- **4** *M* is average molecular weight
- **4** *P* is the maximum absolute relieving pressure:

$$P = P_{\text{max}} + 14.7$$

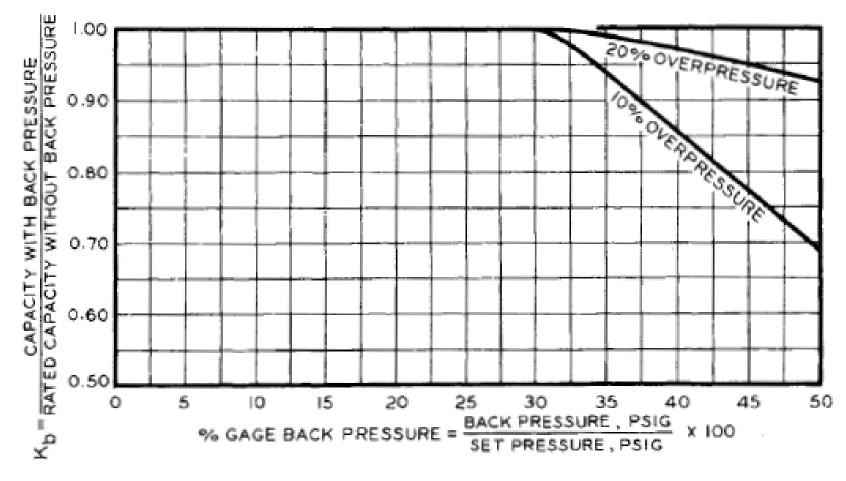
**4** ASME safety guidelines,  $P_s$  = gauge set pressure:

$$P_{\text{max}} = 1.1P_{\text{s}}$$
, unfired vessels  
 $P_{\text{max}} = 1.2P_{\text{s}}$ , vessels exposed to fire  
 $P_{\text{max}} = 1.33P_{\text{s}}$ , piping, Ex 9-2, p 392



#### Backpressure correction $K_{\rm b}$ for conventional springtype reliefs in vapor or gas service. Source: API RP 520

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Backpressure correction  $K_b$  for balanced-bellows reliefs in vapor or gas service. Source: API RP 520

## **Rupture Disks for Liquids**

Use expression for spring relief values for liquids

- Discharge directly to atmosphere or short piping:

$$A = \left[\frac{\operatorname{in}^{2}(\operatorname{psi})^{1/2}}{38.0 \operatorname{gpm}}\right] \frac{Q_{v}}{C_{o}} \sqrt{\frac{\rho / \rho_{ref}}{\Delta P}} \qquad \text{Eqn 9-3, p. 385}$$

**4** Discharge to a relief system:

Flow through the system of pipes and other components must be analyzed as considered in study of source terms.

## **Rupture Disks for Gases**

**4** Use expression for spring relief values for gases **4** For low backpressure levels with no  $K_{\rm b}$  factor:

$$A = \frac{Q_m}{C_o \chi P} \sqrt{\frac{Tz}{M}}$$

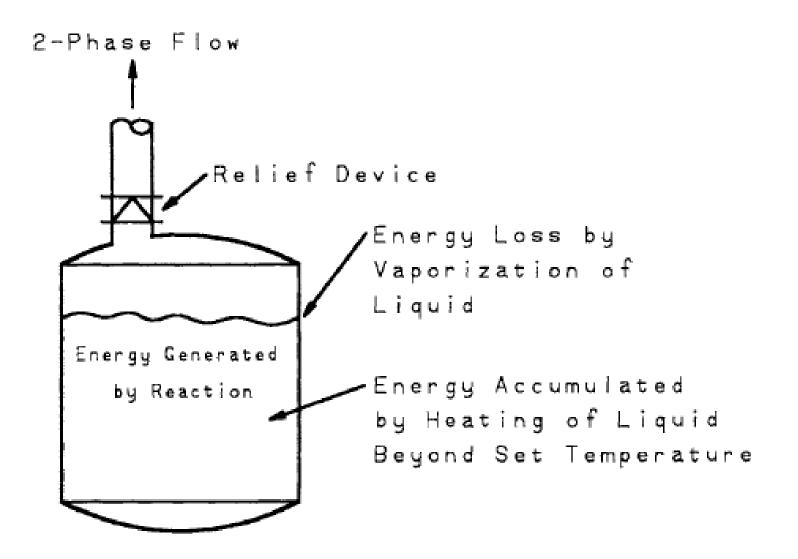
Eqn 9-13, p. 394

Assumes  $C_o = 1$ 

- For significant backpressure levels as into a containment system:
  - Analyze discharge and flow through the entire containment system. Ex 9-3,4, p 395

#### **Two-Phase Relief Behavior**

- Choked, two-phase flow through relief orifice
- Two-phase flow through containment system
- Runaway generally includes flashing during relief; \Delta H<sub>v</sub> removed (reaction is *tempered*)
- **4** Reactor system, large vol/area, ~ adiabatic
- Energy removal only by vaporization and discharge



#### A tempered reaction system

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#### **Two-Phase Mass Discharge**

Liquids at their saturation pressure, saturation temperature, T<sub>s</sub>, the two-phase mass flow rate:

$$Q_{\rm m} = \frac{\Delta H_{\rm v} A}{v_{\rm fg}} \sqrt{\frac{g_{\rm c}}{T_{\rm s} C_{\rm p}}}$$

Eqn 4-104, p. 156

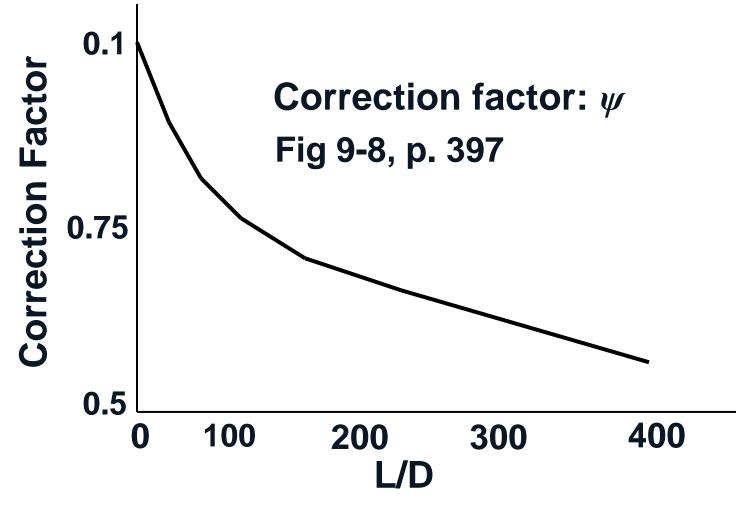
$$v_{\rm fg} = \Delta \overline{V}^{\rm fg}$$

Mass flux with L/D correction factor, ψ, Fig 9-8, p. 397:

$$G_{\rm T} = 0.9\psi \frac{\Delta H_{\rm v}}{v_{\rm fg}} \sqrt{\frac{g_{\rm c}}{C_{\rm p}T_{\rm s}}}$$

Empirical 0.9 factor to match data for homogeneous venting

#### Correction for 2-f Flashing Flow in Pipes



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#### **Two-Phase Mass Discharge**

**4** Clausius Clapyron:  $\frac{dP}{dT} = \frac{\Delta H_v}{Tv_{fg}}$ 

$$G_{\rm T} = 0.9\psi \frac{\Delta P}{\Delta T} \sqrt{\frac{g_{\rm c} T_{\rm s}}{C_{\rm p}}}$$

 $\psi = 1$  for an orifice

$$A = m_{\rm o} \dot{q} / G_{\rm T} \left( \sqrt{\frac{V}{m_{\rm o}} \frac{\Delta H_{\rm v}}{v_{\rm fg}}} + \sqrt{C_{\rm v} \Delta T} \right)^2 m_{\rm o} = \text{mas}$$

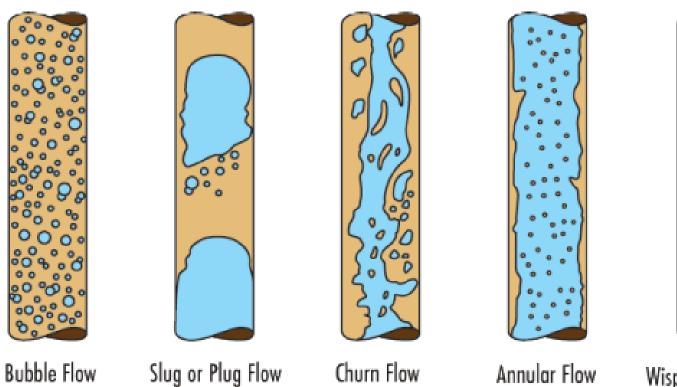
s before release

With CC equation:  $A = m_{o} \dot{q} / G_{T} \left( \sqrt{\frac{V}{m_{o}}} T_{s} \frac{dP}{dT} + \sqrt{C_{v}} \Delta T \right)^{2}$  generated by process, removed by discharge adsorbed by evaporate

Heat terms: qadsorbed by evaporate  $\Delta T$  due to  $\Delta P$  (OP)

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Wispy Annular Flow

0

#### Patterns of two phase flow

## **Thermal Reaction Behavior**

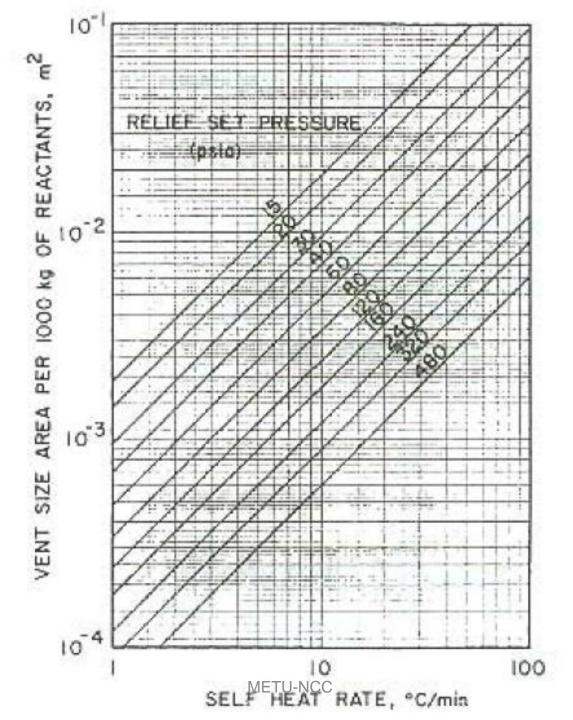
Measure heat input rate using a calorimeter, such as VSP, Fig 8-8, p. 366

$$q = 0.5C_{\rm v} \left[ \left( \frac{dT}{dt} \right)_{\rm s} + \left( \frac{dT}{dt} \right)_{\rm m} \right]$$

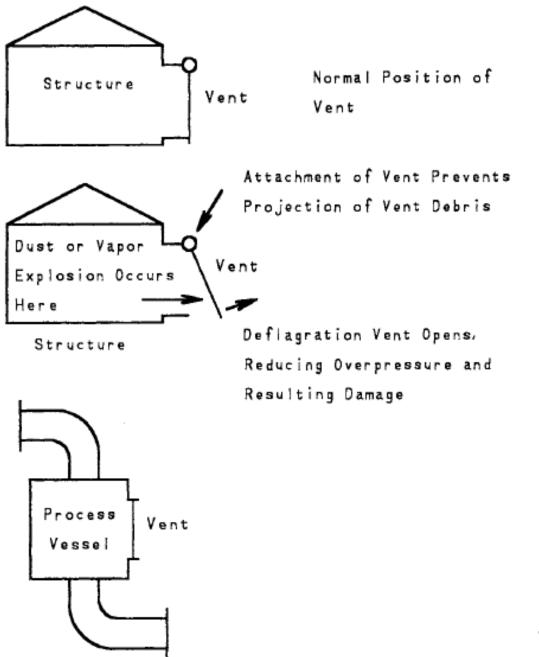
- Measure heating rate at the set pressure and the heating rate at the maximum pressure
- Understand behavior of two-phase releases
- Avoid scenarios that can result in two-phase releases, e.g., overheated polymerization reactor

## **Nomograph Sizing Method**

- A graphical method by Fauske for quick estimates of two-phase release areas uses only this information:
  - Heating rate at the set temperature,  $(dT/dt)_s$
  - Set pressure
  - Mass of reactants
- **4**Obtain a vent size area using Fig 9-9, p. 403
  - Assumes a discharge piping of L/D = 400 (a discharge coefficient = 0.5), and 20 % OP.
- Adjust an area estimate for other L/D ratios and OP values.



29



#### 9-6 Deflagration Venting for Dust and Vapor Explosions

Vents for Low-Pressure Structures

$$A = \frac{C_{\text{vent}}^* L_1 L_2}{\sqrt{P}} \qquad \text{by Runes}$$

A is the required vent area,

- $C^*_{\text{vent}}$  is a constant that depends on the nature of the combustible material,
  - $L_1$  is the smallest dimension of the rectangular building structure to be vented,
  - $L_2$  is the second smallest dimension of the enclosure to be vented, and
  - *P* is the maximum internal pressure that can be withstood by the weakest member of the enclosure.

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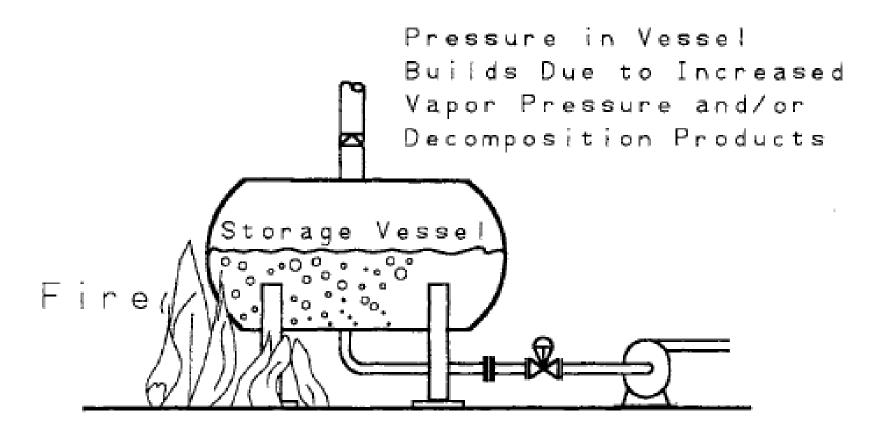
**o Vents for High-Pressure Structures** 

$$K_{\rm G} \text{ or } K_{\rm St} = \left(\frac{dP}{dt}\right)_{\rm max} V^{1/3}$$

 $K_{\rm G}$  is the deflagration index for gases and vapors,  $K_{\rm st}$  is the deflagration index for dusts,  $(dP/dt)_{\rm max}$  is the maximum pressure increase, determined experimentally, and V is the volume of the vessel.

## **Reliefs for Fired Reactors**

- Reactors exposed to external fires: heating and boiling of process liquids and excessive pressures
- Usually exposure at a small part of reactor surface: two-phase foam is smaller amount than from a runaway reaction
- Help prevent two-phase flow during external fire relief: allow a large vapor space above the liquid
- If reactor not protected, firing can lead to reactor failure and result in a BLEVE (p. 282) and if liquid is flammable, a VCE (p. 281)
- Security results more from inherently safer designs

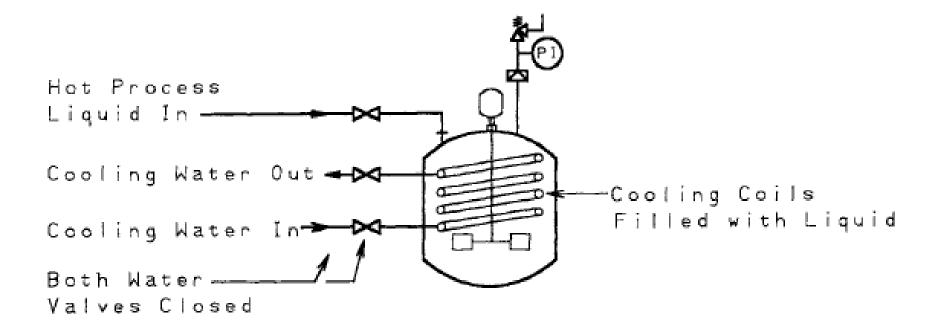


$$A = \frac{Qm_{\rm o}v_{\rm fg}}{G_{\rm T}V\Delta H_{\rm v}}$$

- Q is the constant heat input rate,
- $G_{\rm T}$  is the mass flux through the relief,
  - A is the area of the relief,
- $m_{\rm o}$  is the liquid mass in the vessel,
  - *V* is the volume of the vessel,
- $\Delta H_{\rm v}$  is the heat of vaporization of the liquid.

#### Reliefs for Thermal Expansion of Process Fluids

- Liquids contained process piping expands and damage pipes & vessels
  - **4** Ex; Cooling coil in reactor
  - Contamination of reactor
  - Subsequent corrosion
  - Substantial plant outage
  - **4** Large repair expense



Heat Transfer from Hot Vessel Fluid to Cooling Liquid Increases Cooling Liquid Temperature Leading to Thermal Expansion.

#### Reliefs for Thermal Expansion of Process Fluids

$$\beta = \frac{1}{V} \left( \frac{dV}{dT} \right)$$

Then, the volumetric expansion rate is expressed

$$Q_{v} = \frac{dV}{dt} = \frac{dV}{dT}\frac{dT}{dt} = \beta V \left(\frac{dT}{dt}\right)$$

**Energy balance with external heating** 

$$mC_P \frac{dT}{dt} = UA(T - T_a)$$

#### Reliefs for Thermal Expansion of Process Fluids

#### Then, the volumetric expansion rate is expressed

$$Q_v = \frac{\beta V}{mC_P} UA(T - T_a) = \frac{\beta}{\rho C_P} UA(T - T_a)$$

#### Homework due on Jan/6(Thu) Crowl, Problems 9-1, 2, 5, 19, 28